

# **M.2 2280 PCIe SSD**

Product Name: **UM28P3TND** 

Capacity: 256GB · 512GB · 1TB · 2TB

# **Revision History**

| Revision | Date          | Description     | Editor |
|----------|---------------|-----------------|--------|
| 0        | Apr. 23, 2021 | Initial Release |        |



# **Table of Contents**

| 1.0 General Description               | 5  |
|---------------------------------------|----|
| 1.1 Functional Block                  | 5  |
| 2.0 Mechanical Specification          | 6  |
| 2.1 Physical dimensions and Weight    | 6  |
| 2.2 Product Dimensions                | 6  |
| 3.0 Product Specification             | 7  |
| 3.1 Interface and configuration       | 7  |
| 3.2 Capacity                          | 7  |
| 3.3 Performance                       | 7  |
| 3.3.1 Read/Write & ATTO Performance   | 7  |
| 3.3.2 Read/Write & CDM Performance    | 7  |
| 3.3.3 IOPS Performance                | 8  |
| 3.3.4 Read/Write & AS-SSD Performance | 8  |
| 3.4 Electrical                        | 8  |
| 3.4.1 Operating Voltage               | 8  |
| 3.4.2 Power Consumption (Typical)     | 9  |
| 3.5 Environmental Conditions          | 9  |
| 3.6 Reliability                       | 9  |
| 3.7 Endurance                         | 9  |
| 4.0 Supported Command Sets            | 10 |
| 4.1 Identify Command                  | 10 |
| 4.2 SMART/Health Information          | 11 |
| 5.0 Pin assignment and descriptions   | 14 |
| 6.0 Product Line up                   | 15 |
| 7.0 Package Specifications            | 15 |



# **Key Features**

• Capacity:

■ 256GB, 512GB, 1TB, 2TB

• NAND Flash: 3D TLC 96L

• **DRAM Buffer:** DDR3

• Form Factor: M.2 2280

• Host Interface:

■ PCle Gen 3 (8Gb/s) x 4 Lane

Compliant with NVMe 1.3 register
 interface and command set

■ Compliant with PCIe Express 3.1

Flash Management:

➤ LDPC ECC Engine

RAID Engine

Global Wear leveling

Bad block Management

Garbage collection

> TRIM Command

SLC Cache Technology

Data Integrity:

Thermal Throttling

■ S.M.A.R.T Monitor

End to End data path protection

Performance:

Sequential Read: Up to 3400 MB/s

■ Sequential Write: Up to 2800 MB/s

Random 4K Read: Up to 150K IOPS

■ Random 4K Write: Up to 100K IOPS

Power Consumption:

■ L0: 0.7W

■ L1: 0.02W

■ L1.2: 0.004W

■ Sequential Read/Write: 5.2W/5.8W

■ Random Read/Write: 3.7W/3W

Temperature:

■ Standard: 0°C ~ 70°C

■ Non-operation: -55°C ~ 95°C

Reliability:

■ Shock: 1500G/0.5ms

■ Vibration 20G Peak, 20~2000Hz

■ MTBF: 3,000,000 hours

Endurance:

■ TBW : Up to 2000TB



# 1.0 General Description

The UNiCORE UM28P3TND NVMe 1.3 PCIe Gen3x4 M.2 2280 solid state drive utilizes 3D NAND flash and provides superb R/W performance of up to 3400/2800MB per second. Its P/E cycle has been upgraded to 3K and can operate normally in harsh environment from 0°C to 70°C for excellent endurance, reliability, and stability. In addition, it supports RAID Engine and End to End (E2E) Data Protection for data integrity and safety. For enhanced data security, the UM28P3TND comes with AES 256-bit encryption (optional) and meets TCG Opal standard (optional). Not only is the UM28P3TND suitable for notebooks, desktops, servers and data centers of all types, it can also serve as a boot drive for surveillance and transportation systems. To safeguard quality, compatibility, and reliability, ADATA uses a rigorous SSD validation process that encompasses performance testing and quality assurance to ensure its SSDs meet the exacting requirements of industrial applications.

# 1.1 Functional Block

SPI Loader IROM PCIe PHY Instruction Cache Instruction Cache **NAND Flash** Data Cache **Data Cache** Controller NAND PCIe MAC **PCle** (8-channel) ITCM ITCM Flash Host Arrays DTCM DTCM PCIe Core Share DTCM (NVMe) **ARM Cortex ARM Cortex** DSP Core 0 Core 1 LDPC Security Engine **RAID Codec** 

Figure 1-1 Functional Block



# 2.0 Mechanical Specification

All product specifications not covered in this document (electrical performance, appearance, etc.) are in accordance with YTY UNICORE's defined norms and standards.

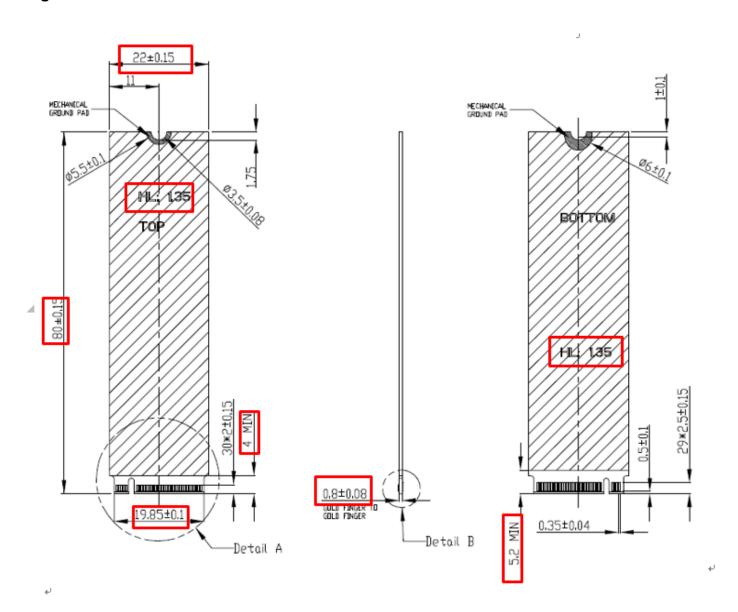
# 2.1 Physical dimensions and Weight

**Table 2-1 Dimensions and Weight** 

| Model | Length (mm)    | Width (mm)     | Height (mm) | Weight (gram) |
|-------|----------------|----------------|-------------|---------------|
| 256   | 80.00 +/- 0.15 | 22.00 +/- 0.15 | Max 2.25    | 6.2 +/- 0.2   |
| 512   | 80.00 +/- 0.15 | 22.00 +/- 0.15 | Max 2.25    | 6.9 +/- 0.2   |
| 1024  | 80.00 +/- 0.15 | 22.00 +/- 0.15 | Max 2.25    | 7.0 +/- 0.2   |
| 2048  | 80.00 +/- 0.15 | 22.00 +/- 0.15 | Max 2.25    | 7.0 +/- 0.2   |

# 2.2 Product Dimensions

**Figure 2-1 Product Dimensions** 





# 3.0 Product Specification

# 3.1 Interface and configuration

- Compliant with PCI Express M.2 Specification Revision 1.1.
- Compliant with NVMe 1.3 register interface and command set.
- Compliant with PCIe Express 3.1.

# 3.2 Capacity

#### **Table 3-1 User Addressable Sectors**

| Model                                     | UM28P3TND   |               |               |               |  |
|---|-------------|---------------|---------------|---------------|--|
| Unformatted Capacity                      | 256GB       | 512GB         | 1TB           | 2TB           |  |
| Total User Addressable Sectors (LBA Mode) | 500,118,192 | 1,000,215,216 | 2,000,409,264 | 4,000,797,360 |  |

Total useable capacity may be less (duo to formatting, flash management, and other functions). 1GB=1,000,000,000 bytes; 1sector = 512bytes.

### 3.3 Performance

#### 3.3.1 Read/Write & ATTO Performance

### **Table 3-2 Read/Write Performance (ATTO)**

|                  | 256GB | 512GB | 1TB  | 2TB  | Unit |
|------------------|-------|-------|------|------|------|
| Sequential Read  | 3300  | 3300  | 3300 | 3300 | MB/s |
| Sequential Write | 1200  | 2400  | 1900 | 2800 | MB/s |

<sup>-</sup>Seq. Read & Write speed test by ATTO

#### 3.3.2 Read/Write & CDM Performance

## Table 3-3 Read/Write Performance (CDM)

|                      | 256GB | 512GB | 1TB  | 2TB  | Unit |
|----------------------|-------|-------|------|------|------|
| Sequential Q32 Read  | 3400  | 3400  | 3400 | 3400 | MB/s |
| Sequential Q32 Write | 1200  | 2300  | 1800 | 2800 | MB/s |

-Seq. Read & Write speed test by Crystal Disk Mark 5.1.2



<sup>-</sup>The system conditions and test environment may affect test result

#### 3.3.3 IOPS Performance

#### Table 3-4 Read/Write & IOPS Performance

|                 | 256GB | 512GB | 1TB  | 2TB  | Unit |
|-----------------|-------|-------|------|------|------|
| 4K Random Read  | 110K  | 145K  | 145K | 150K | IOPS |
| 4K Random Write | 70K   | 100K  | 100K | 100K | IOPS |

<sup>-</sup>Seq. Read & Write speed test by IOmeter 2010 with "00" pattern (Queue depth of 32; Measurements are performed on 10% capacity of LBA range. Write cache enable)

#### 3.3.4 Read/Write & AS-SSD Performance

# Table 3-5 Read/Write Performance (AS-SSD)

|                  | 256GB | 512GB | 1TB  | 2TB  | Unit |
|------------------|-------|-------|------|------|------|
| Sequential Read  | 2800  | 2800  | 2800 | 2800 | MB/s |
| Sequential Write | 1000  | 2100  | 1700 | 2300 | MB/s |
| 4K-64 Thrd Read  | 640   | 1200  | 1000 | 1200 | MB/s |
| 4K-64 Thrd Write | 490   | 1300  | 1300 | 1200 | MB/s |

<sup>-</sup>Seq. Read & Write speed test by AS-SSD with Random pattern

## 3.4 Electrical

## 3.4.1 Operating Voltage

#### **Table 3-6 Operating Voltage**

| Operating Voltage                |  |  |  |
|----------------------------------|--|--|--|
| Input Power DC 3.3V ± 5%         |  |  |  |
| Maximum Ripple 100mV p-p or less |  |  |  |



<sup>-</sup>IOPS Test Utility: IOmeter 2010 (Queue depth of 32; Measurements are performed on 10% capacity of LBA range. Write cache enable)

<sup>-</sup>Different system conditions and test environments may affect test results

### 3.4.2 Power Consumption (Typical)

## **Table 3-7 Power Consumption (Typical)**

|                  | 256GB | 512GB | 1TB   | 2TB   | Unit |
|------------------|-------|-------|-------|-------|------|
| L0               | 0.7   | 0.7   | 0.7   | 0.7   | w    |
| L1               | 0.02  | 0.02  | 0.02  | 0.02  | w    |
| L1.2             | 0.004 | 0.004 | 0.004 | 0.004 | w    |
| Sequential Read  | 5.6   | 4.6   | 5.2   | 5.2   | w    |
| Sequential Write | 3.8   | 5.2   | 4.5   | 5.8   | w    |
| Random Read      | 3.6   | 4.1   | 3.5   | 3.7   | w    |
| Random Write     | 1.9   | 2.3   | 3.0   | 3.0   | W    |

<sup>-</sup> The typical value means to measure the power consumption by using IO Meter with 128KB Sequential and 4K Random read/write transfers within 15 minutes.

#### 3.5 Environmental Conditions

# Table 3-8 Temperature, Humidity

| Feature              | Operating                 | Non-Operating |
|----------------------|---------------------------|---------------|
| Standard Temperature | 0°C to 70°C               | -55°C to 95°C |
| Humidity             | 5%~95% RH, non-condensing |               |

# 3.6 Reliability

#### **Table 3-9 Shock and Vibration**

| Parameter | Conditions                                    | Reference Standards |
|-----------|---|---------------------|
| Shock     | 1500G, 3 axes, duration 0.5ms, Half Sine Wave | JESD22-B110         |
| Vibration | 20G , 3 axes , Peak, 20~2000Hz                | JESD22-B103         |

#### Table 3-10 MTBF

| Parameter | Conditions   | Hours     |  |
|-----------|--------------|-----------|--|
| MTBF      | MIL-HDBK-217 | 3,000,000 |  |

## 3.7 Endurance

Endurance for the SSD can be predicted based on the operating workload .The tables as below shows the drive lifetime for each SSD capacity based JESD219 client workload.

**Table 3-10 Tera Byte Written** 

|                             | 256GB | 512GB | 1TB  | 2TB  | Unit |
|-----------------------------|-------|-------|------|------|------|
| Total Byte Written<br>(TBW) | 250   | 500   | 1000 | 2000 | ТВ   |



<sup>-</sup> The measurement may vary among different host systems and settings.

# **4.0 Supported Command Sets**

# **4.1 Identify Command**

UNICORE SSD follows NVMe 1.3 Specification and responds to identify command with a predefined string of information listed in Identify Controller Data structure.

**Table 4-1 Identify Controller Data Structure Table** 

| Bytes     | Description                            |  |  |  |
|-----------|--|--|--|--|
| 0-1       | PCI Vendor ID(VID)                     |  |  |  |
| 2-3       | PCI Subsystem Vendor ID(SSVID)         |  |  |  |
| 4-23      | Serial Number (SN)                     |  |  |  |
| 24-63     | Model Number (MN)                      |  |  |  |
| 64-71     | Firmware Revision (FR)                 |  |  |  |
| 72        | Recommended Arbitration Burst (RAB)    |  |  |  |
| 73-75     | IEEE OUI Identifier (IEEE)             |  |  |  |
| 76        | Multi-Interface Capabilities (MIC)     |  |  |  |
| 77        | Max Data Transfer Size (MDTS)          |  |  |  |
| 256-257   | Optional Admin Command Support (OACS)  |  |  |  |
| 258       | Abort Command Limit (ACL)              |  |  |  |
| 259       | Asynchronous Event Request Limit(AERL) |  |  |  |
| 260       | Firmware Update(FRMW)                  |  |  |  |
| 261       | Log Page Attributes(LPA)               |  |  |  |
| 262       | Error Log Page Entries(ELPE)           |  |  |  |
| 263       | Number of Power States Support(NPSS)   |  |  |  |
| 512       | Submission Queue Entry Size            |  |  |  |
| 513       | Completion Queue Entry Size            |  |  |  |
| 516-519   | Number of Namespaces(NN)               |  |  |  |
| 520-521   | Optional NVM command Support(ONCS)     |  |  |  |
| 522-523   | Fused Operation Support(FUSES)         |  |  |  |
| 524       | Format NVM Attributes(FNA)             |  |  |  |
| 525       | Volatile Write Cache(VWC)              |  |  |  |
| 526-527   | Atomic Write Unit Normal(AWUN)         |  |  |  |
| 528-529   | Atomic Write Unit Power Fail(AWUPF)    |  |  |  |
| 2048-2079 | Power State 0 Descriptor(PSD0)         |  |  |  |



# **4.2 SMART/Health Information**

**Table 4-2 SMART/Health Information log** 

| Byte | Description   |  |  |  |  |
|------|---|--|--|--|--|
| 0    | Critical Warr   | Critical Warning: This field indicates critical warnings for the state of the controller. Each bit |  |  |  |
|      | corresponds   | corresponds to a critical warning type; multiple bits may be set. If a bit is cleared to '0', then |  |  |  |
|      | that critical wa  | arning does not apply. Critical warnings may result in an asynchronous event                       |  |  |  |
|      | notification to   | the host. Bits in this field represent the current associated state and are not                    |  |  |  |
|      | persistent.   | persistent.  |  |  |  |
|      | Bit   | Definition   |  |  |  |
|      | 00  | If set to '1', then the available spare space has fallen below the threshold.                      |  |  |  |
|      | 01  | If set to '1', then a temperature is above an over temperature threshold or                        |  |  |  |
|      |   | below an under temperature threshold (refer to section 5.15.1.4).                                  |  |  |  |
|      | 02  | If set to '1', then the NVM subsystem reliability has been degraded due to                         |  |  |  |
|      |   | significant media related errors or any internal error that degrades NVM                           |  |  |  |
|      |   | subsystem reliability.   |  |  |  |
|      | 03  | If set to '1', then the media has been placed in read only mode.                                   |  |  |  |
|      | 04  | If set to '1', then the volatile memory backup device has failed. This field is                    |  |  |  |
|      |   | only valid if the controller has a volatile memory backup solution.                                |  |  |  |
|      | 07:05   | Reserved   |  |  |  |
|      |   |  |  |  |  |
| 2:1  | Composite Temperature: Contains a value corresponding to a temperature in degrees             |  |  |  |  |
|      | Kelvin that represents the current composite temperature of the controller and namespace(s)   |  |  |  |  |
|      | associated with that controller. The manner in which this value is computed is implementation |  |  |  |  |
|      | specific and may not represent the actual temperature of any physical point in the NVM        |  |  |  |  |
|      | subsystem. The value of this field may be used to trigger an asynchronous event (refer to     |  |  |  |  |
|      | section 5.15.1.4).  |  |  |  |  |
|      | Warning and critical overheating composite temperature threshold values are reported by       |  |  |  |  |
|      | the WCTEMP and CCTEMP fields in the Identify Controller data structure in Figure 90.          |  |  |  |  |
| 3    | Available Spare: Contains a normalized percentage (0 to 100%) of the remaining spare          |  |  |  |  |
|      | capacity available.   |  |  |  |  |
| 4    | Available Sp  | pare Threshold: When the Available Spare falls below the threshold indicated                       |  |  |  |
|      | in this field, an asynchronous event completion may occur. The value is indicated as a        |  |  |  |  |
|      | normalized percentage (0 to 100%).  |  |  |  |  |
| 5    | Percentage Used: Contains a vendor specific estimate of the percentage of NVM                 |  |  |  |  |
|      | subsystem life used based on the actual usage and the manufacturer's prediction of NVM        |  |  |  |  |
|      | life. A value of 100 indicates that the estimated endurance of the NVM in the NVM subsystem   |  |  |  |  |
|      | has been consumed, but may not indicate an NVM subsystem failure. The value is allowed        |  |  |  |  |
|      | to exceed   |  |  |  |  |
|      | 100. Percentages greater than 254 shall be represented as 255. This value shall be updated    |  |  |  |  |
|      | once per power-on hour (when the controller is not in a sleep state).                         |  |  |  |  |
|      | Refer to the JEDEC JESD218A standard for SSD device life and endurance measurement            |  |  |  |  |
|      | techniques.   | techniques.  |  |  |  |



| 31:6    | Reserved   |  |  |  |
|---------|--|--|--|--|
| 47:32   | Data Units Read: Contains the number of 512 byte data units the host has read from the           |  |  |  |
|         | controller; this value does not include metadata. This value is reported in thousands (i.e., a   |  |  |  |
|         | value of 1 corresponds to 1000 units of 512 bytes read) and is rounded up. When the LBA          |  |  |  |
|         | size is a value other than 512 bytes, the controller shall convert the amount of data read to    |  |  |  |
|         | 512 byte units.  |  |  |  |
|         | For the NVM command set, logical blocks read as part of Compare and Read operations shall        |  |  |  |
|         | be included in this value.   |  |  |  |
| 63:48   | Data Units Written: Contains the number of 512 byte data units the host has written to the       |  |  |  |
|         | controller; this value does not include metadata. This value is reported in thousands (i.e., a   |  |  |  |
|         | value of 1 corresponds to 1000 units of 512 bytes written) and is rounded up. When the LBA       |  |  |  |
|         | size is a value other than 512 bytes, the controller shall convert the amount of data written to |  |  |  |
|         | 512 byte units.  |  |  |  |
|         | For the NVM command set, logical blocks written as part of Write operations shall be included    |  |  |  |
|         | in this value. Write Uncorrectable commands shall not impact this value.                         |  |  |  |
| 79:64   | Host Read Commands: Contains the number of read commands completed by the                        |  |  |  |
| 7 9.04  | controller.  |  |  |  |
|         | For the NVM command set, this is the number of Compare and Read commands.                        |  |  |  |
| 95:80   |  |  |  |  |
| 93.00   | <b>Host Write Commands:</b> Contains the number of write commands completed by the controller.   |  |  |  |
|         | For the NVM command set, this is the number of Write commands.                                   |  |  |  |
| 111:96  |  |  |  |  |
| 111.90  | Controller Busy Time: Contains the amount of time the controller is busy with I/O                |  |  |  |
|         | commands. The controller is busy when there is a command outstanding to an I/O Queue             |  |  |  |
|         | (specifically, a command was issued via an I/O Submission Queue Tail doorbell write and          |  |  |  |
|         | the corresponding completion queue entry has not been posted yet to the associated I/O           |  |  |  |
| 407:440 | Completion Queue). This value is reported in minutes.  |  |  |  |
| 127:112 | Power Cycles: Contains the number of power cycles.   |  |  |  |
| 143:128 | <b>Power On Hours:</b> Contains the number of power-on hours. This may not include time that     |  |  |  |
|         | the controller was powered and in a non-operational power state.                                 |  |  |  |
| 159:144 | Unsafe Shutdowns: Contains the number of unsafe shutdowns. This count is incremented             |  |  |  |
|         | when a shutdown notification (CC.SHN) is not received prior to loss of power.                    |  |  |  |
| 175:160 | Media and Data Integrity Errors: Contains the number of occurrences where the controller         |  |  |  |
|         | detected an unrecovered data integrity error. Errors such as uncorrectable ECC, CRC              |  |  |  |
|         | checksum failure, or LBA tag mismatch are included in this field.                                |  |  |  |
| 191:176 | Number of Error Information Log Entries: Contains the number of Error Information log            |  |  |  |
|         | entries over the life of the controller.   |  |  |  |
| 195:192 | Warning Composite Temperature Time: Contains the amount of time in minutes that the              |  |  |  |
|         | controller is operational and the Composite Temperature is greater than or equal to the          |  |  |  |
|         | Warning Composite Temperature Threshold (WCTEMP) field and less than the Critical                |  |  |  |
|         | Composite Temperature Threshold (CCTEMP) field in the Identify Controller data structure         |  |  |  |
|         | in Figure 90.  |  |  |  |
| Ì       | If the value of the WCTEMP or CCTEMP field is 0h, then this field is always cleared to 0h        |  |  |  |



| r       |   |  |  |  |
|---------|---|--|--|--|
|         | regardless of the Composite Temperature value.  |  |  |  |
| 199:196 | Critical Composite Temperature Time: Contains the amount of time in minutes that the          |  |  |  |
|         | controller is operational and the Composite Temperature is greater than the Critical          |  |  |  |
|         | Composite Temperature Threshold (CCTEMP) field in the Identify Controller data structure      |  |  |  |
|         | in Figure 90.   |  |  |  |
|         | If the value of the CCTEMP field is 0h, then this field is always cleared to 0h regardless of |  |  |  |
|         | the Composite Temperature value.  |  |  |  |
| 201:200 | Temperature Sensor 1: Contains the current temperature reported by temperature sensor         |  |  |  |
|         | 1. This field is defined by Figure 81.  |  |  |  |
| 203:202 | Temperature Sensor 2: Contains the current temperature reported by temperature sensor         |  |  |  |
|         | 2. This field is defined by Figure 81.  |  |  |  |
| 205:204 | Temperature Sensor 3: Contains the current temperature reported by temperature sensor         |  |  |  |
|         | 3. This field is defined by Figure 81.  |  |  |  |
| 207:206 | Temperature Sensor 4: Contains the current temperature reported by temperature sensor         |  |  |  |
|         | 4. This field is defined by Figure 81.  |  |  |  |
| 209:208 | Temperature Sensor 5: Contains the current temperature reported by temperature sensor         |  |  |  |
|         | 5. This field is defined by Figure 81.  |  |  |  |
| 211:210 | Temperature Sensor 6: Contains the current temperature reported by temperature sensor         |  |  |  |
|         | 6. This field is defined by Figure 81.  |  |  |  |
| 213:212 | Temperature Sensor 7: Contains the current temperature reported by temperature sensor         |  |  |  |
|         | 7. This field is defined by Figure 81.  |  |  |  |
| 215:214 | Temperature Sensor 8: Contains the current temperature reported by temperature sensor         |  |  |  |
|         | 8. This field is defined by Figure 81.  |  |  |  |
| 511:216 | Reserved  |  |  |  |



# **5.0 Pin assignment and descriptions**

Table 5-1 Pin assignment and descriptions

| Top Side |       |               | Bottom Side   |          |     |  |
|----------|-------|---------------|---------------|----------|-----|--|
| NO.      | Pin   | Descriptions  | Descriptions  | Pin      | NO. |  |
| 75       | GND   | System Ground |               |          |     |  |
| 73       | GND   | System Ground | +3.3V         | POWER    | 74  |  |
| 71       | GND   | System Ground | +3.3V         | POWER    | 72  |  |
| 69       | PDEDC | PDEDC         | +3.3V         | POWER    | 70  |  |
| 67       | NC    | NC            | SUSCLK        | SUSCLK   | 68  |  |
|          |       | M             | -KEY          |          |     |  |
| 57       | GND   | System Ground | MFG_CLK       | UART     | 58  |  |
| 55       | Diff  | RefCLKP       | MFG_DATA      | UART     | 56  |  |
| 53       | Diff  | RefCLKN       | PEWAKE#       | PEWAKE   | 54  |  |
| 51       | GND   | System Ground | CLKREQ#       | CLKREQ   | 52  |  |
| 49       | Diff  | P0RXP         | PERST#        | PERST    | 50  |  |
| 47       | Diff  | PORXN         | NC            | NC       | 48  |  |
| 45       | GND   | System Ground | NC            | NC       | 46  |  |
| 43       | Diff  | P0TXP         | ALERT#        | ALERT    | 44  |  |
| 41       | Diff  | P0TXN         | SMB_DATA      | I2C      | 42  |  |
| 39       | GND   | System Ground | SMB_CLK       | I2C      | 40  |  |
| 37       | Diff  | P1RXP         | NC            | NC       | 38  |  |
| 35       | Diff  | P1RXN         | NC            | NC       | 36  |  |
| 33       | GND   | System Ground | NC            | NC       | 34  |  |
| 31       | Diff  | P1TXP         | NC            | NC       | 32  |  |
| 29       | Diff  | P1TXN         | NC            | NC       | 30  |  |
| 27       | GND   | System Ground | NC            | NC       | 28  |  |
| 25       | Diff  | P2RXP         | NC            | NC       | 26  |  |
| 23       | Diff  | P2RXN         | NC            | NC       | 24  |  |
| 21       | GND   | System Ground | NC            | NC       | 22  |  |
| 19       | Diff  | P2TXP         | NC            | NC       | 20  |  |
| 17       | Diff  | P2TXN         | +3.3V         | POWER    | 18  |  |
| 15       | GND   | System Ground | +3.3V         | POWER    | 16  |  |
| 13       | Diff  | P3RXP         | +3.3V         | POWER    | 14  |  |
| 11       | Diff  | P3RXN         | +3.3V         | POWER    | 12  |  |
| 9        | GND   | System Ground | LED1#(OPTION) | INDICATE | 10  |  |
| 7        | Diff  | P3TXP         | NC            | NC       | 8   |  |
| 5        | Diff  | P3TXN         | NC            | NC       | 6   |  |
| 3        | GND   | System Ground | +3.3V         | POWER    | 4   |  |
| 1        | GND   | System Ground | +3.3V         | POWER    | 2   |  |
|          |       | •             | •             |          |     |  |



# 6.0 Product Line up

Table 6-1 Product Line up

| Model Name        | Capacity | P/E cycles | Туре     | Remark   |  |
|-------------------|----------|------------|----------|----------|--|
| UM28P3TND-256GNS8 | 256GB    | ЗК         | M.2 2280 |          |  |
| UM28P3TND-512GNS8 | 512GB    | 3K         | M.2 2280 | 0°C~70°C |  |
| UM28P3TND-001TNS8 | 1TB      | 3K         | M.2 2280 |          |  |
| UM28P3TND-002TNS8 | 2TB      | 3K         | M.2 2280 |          |  |

# 7.0 Package Specifications

Figure 7-1 Package Specification

